

To our customers,

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## Old Company Name in Catalogs and Other Documents

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April 1<sup>st</sup>, 2010  
Renesas Electronics Corporation

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EOL announced product

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## 2SC2619

Silicon NPN Epitaxial

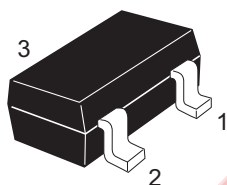
REJ03G0703-0200  
 (Previous ADE-208-1070)  
 Rev.2.00  
 Aug.10.2005

### Application

High frequency amplifier

### Outline

RENESAS Package code: PLSP0003ZB-A  
 (Package name: MPAK)



1. Emitter
2. Base
3. Collector

### Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Ratings	Unit
Collector to base voltage	$V_{CBO}$	30	V
Collector to emitter voltage	$V_{CEO}$	30	V
Emitter to base voltage	$V_{EBO}$	5	V
Collector current	$I_C$	100	mA
Collector power dissipation	$P_C$	150	mW
Junction temperature	$T_j$	150	°C
Storage temperature	$T_{stg}$	-55 to +150	°C

## Electrical Characteristics

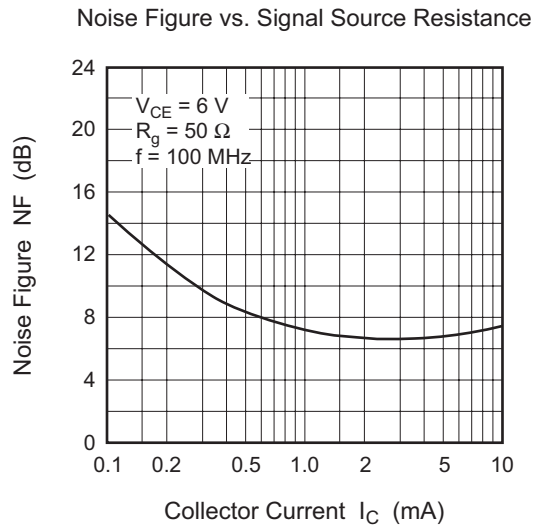
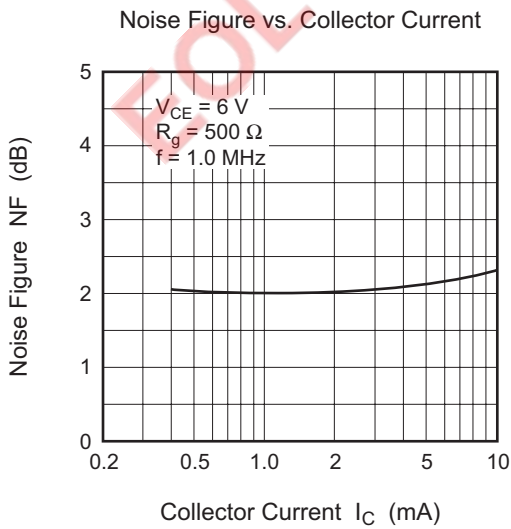
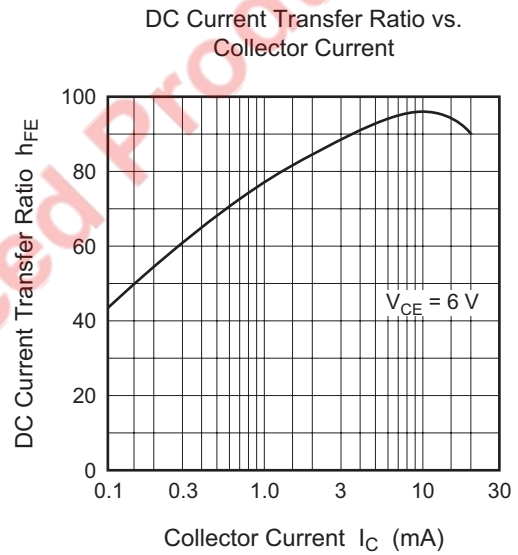
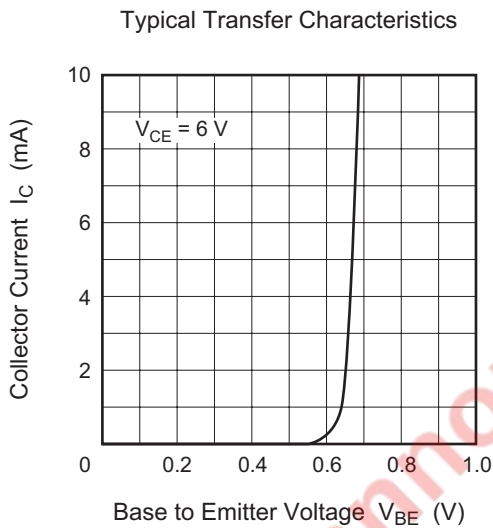
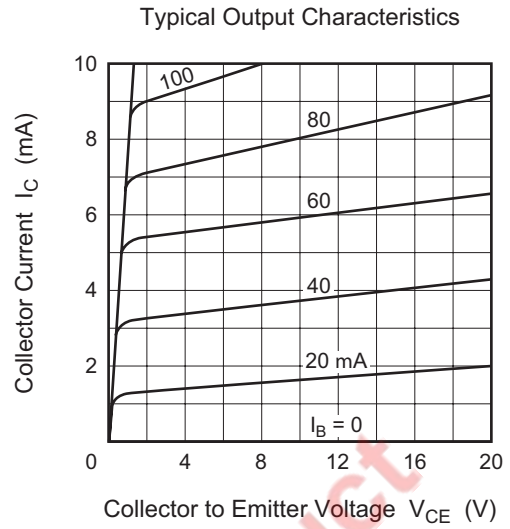
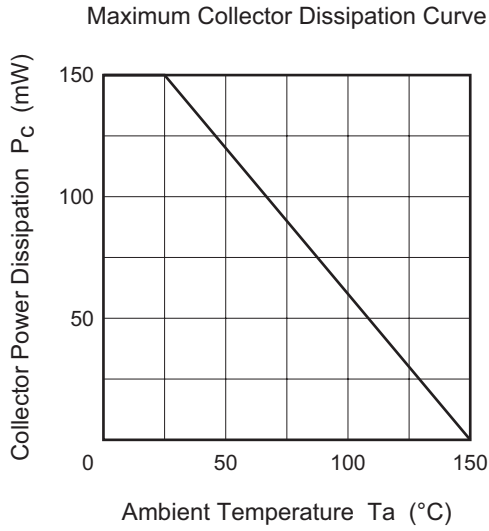
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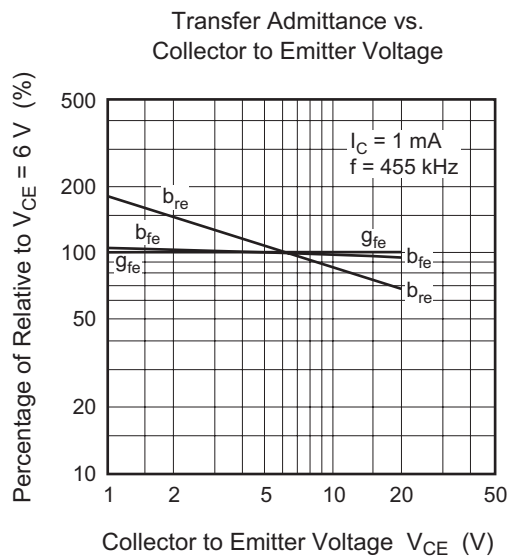
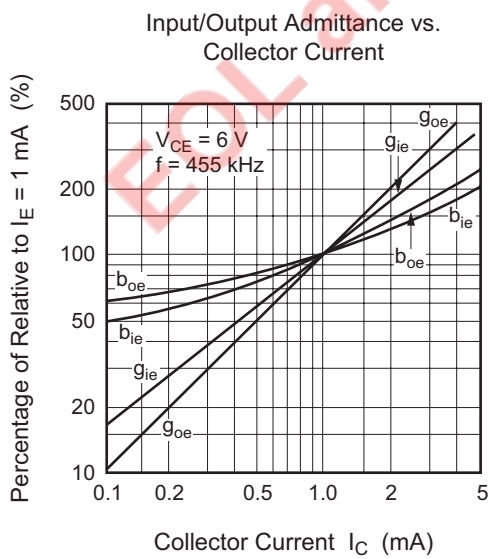
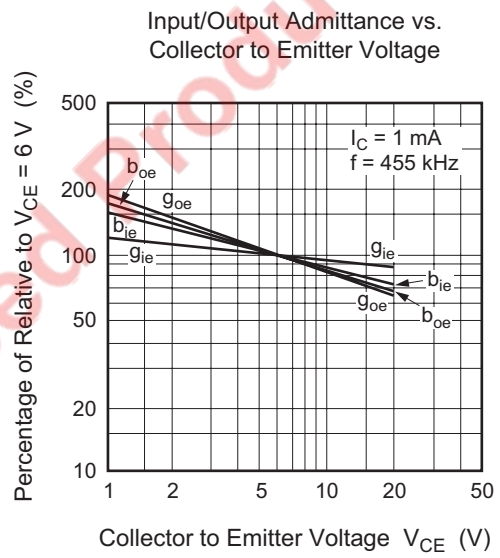
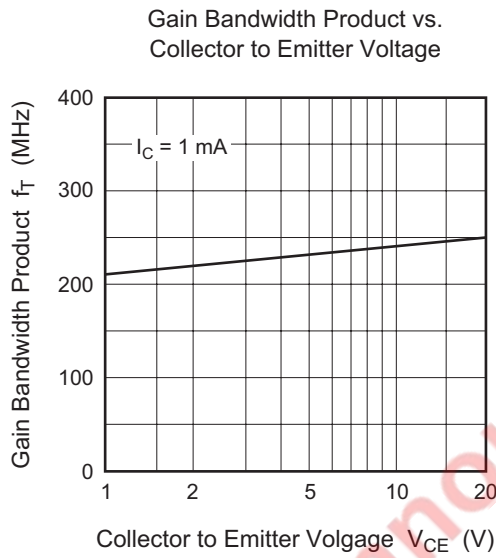
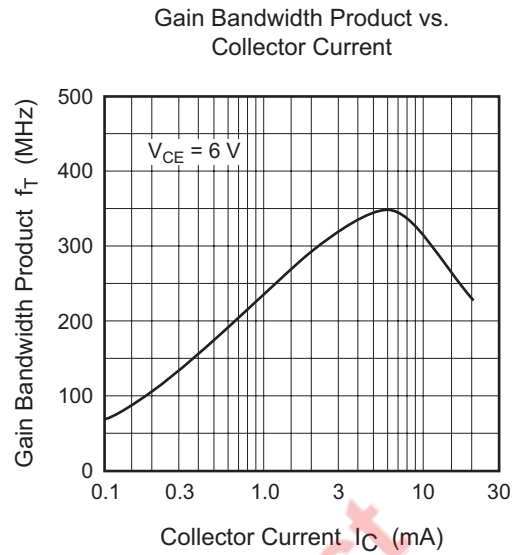
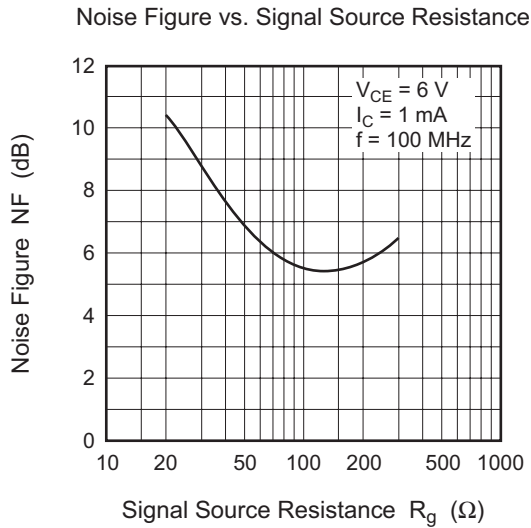
Item	Symbol	Min	Typ	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	30	—	—	V	$I_C = 10 \mu A, I_E = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	30	—	—	V	$I_C = 1 \text{ mA}, R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	5	—	—	V	$I_E = 10 \mu A, I_C = 0$
Collector cutoff current	$I_{CBO}$	—	—	0.5	$\mu A$	$V_{CB} = 20 \text{ V}, I_C = 0$
Emitter cutoff current	$I_{EBO}$	—	—	0.5	$\mu A$	$V_{EB} = 2 \text{ V}, I_C = 0$
DC current transfer ratio	$h_{FE}^{*1}$	60	—	200		$V_{CE} = 12 \text{ V}, I_C = 2 \text{ mA}$
Collector to emitter saturation voltage	$V_{CE(sat)}$	—	—	1.1	V	$I_C = 10 \text{ mA}, I_B = 1 \text{ mA}$
Base to emitter voltage	$V_{BE}$	—	—	0.75	V	$V_{CE} = 12 \text{ V}, I_C = 2 \text{ mA}$
Gain bandwidth product	$f_T$	—	230	—	MHz	$V_{CE} = 12 \text{ V}, I_C = 2 \text{ mA}$
Collector output capacitance	$C_{ob}$	—	—	3.5	pF	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$
Noise figure	NF	—	5.0	—	dB	$V_{CE} = 6 \text{ V}, I_C = 2 \text{ mA}, f = 1 \text{ MHz}, R_g = 500 \Omega$

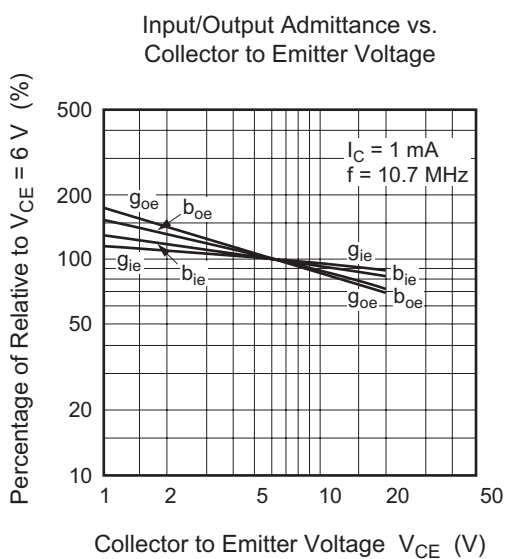
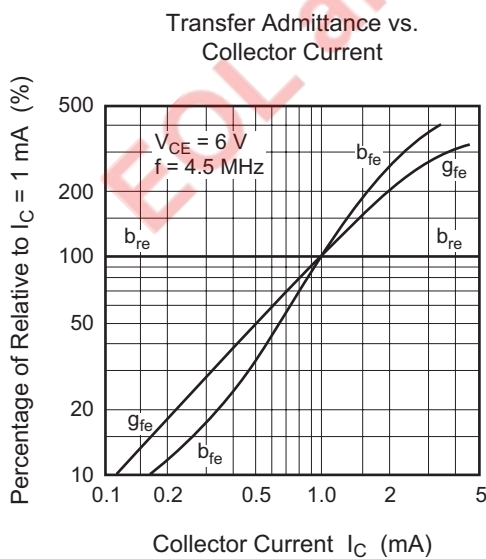
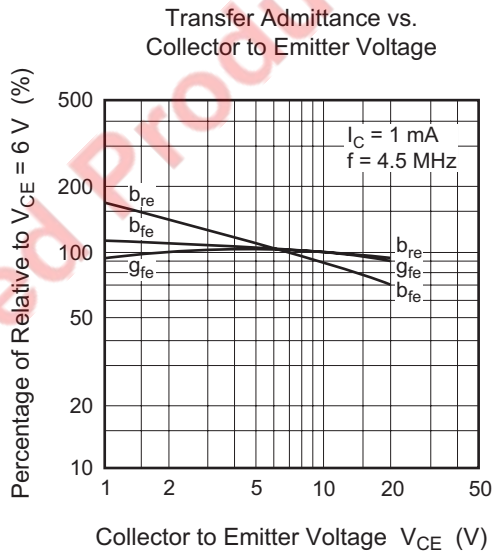
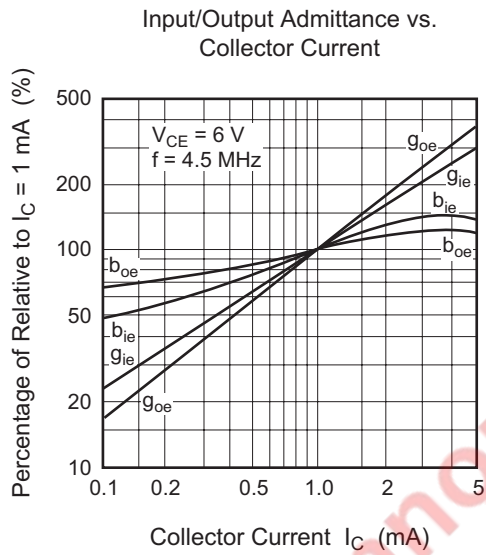
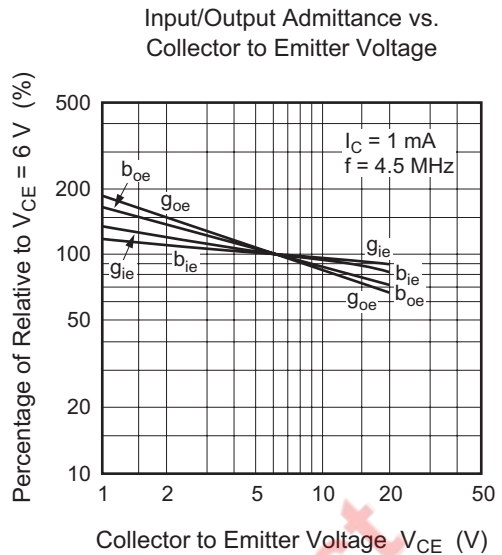
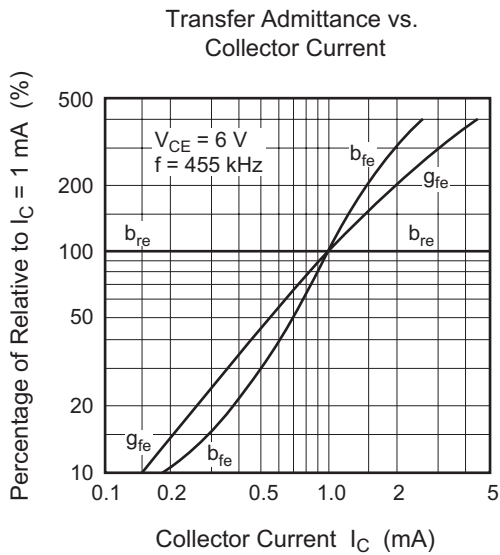
Note: 1. The 2SC2619 is grouped by  $h_{FE}$  as follows.

Grade	B	C
Mark	FB	FC
$h_{FE}$	60 to 120	100 to 200

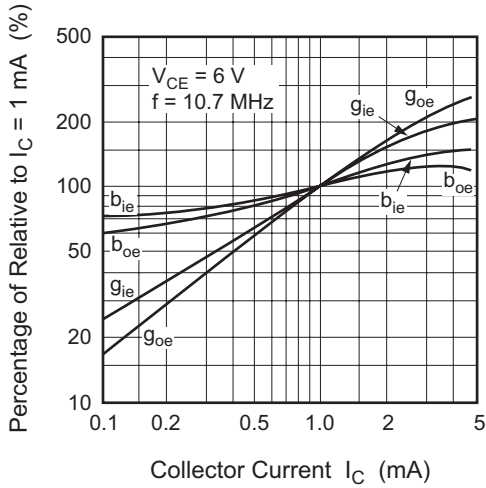
Main Characteristics



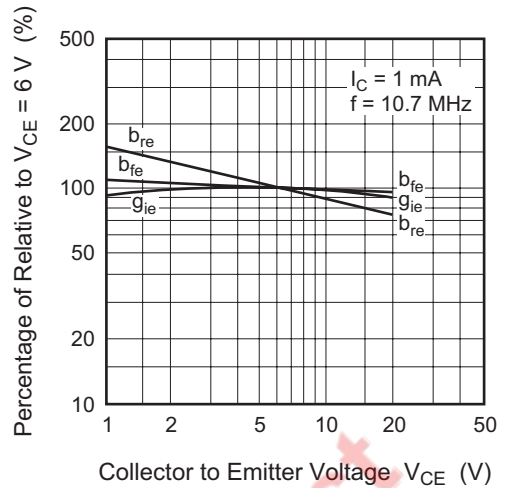




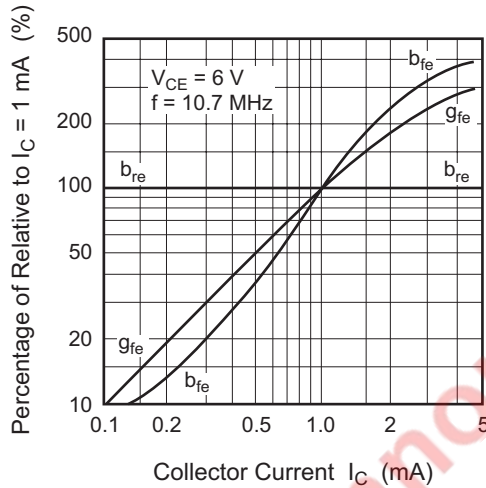
Input/Output Admittance vs. Collector Current



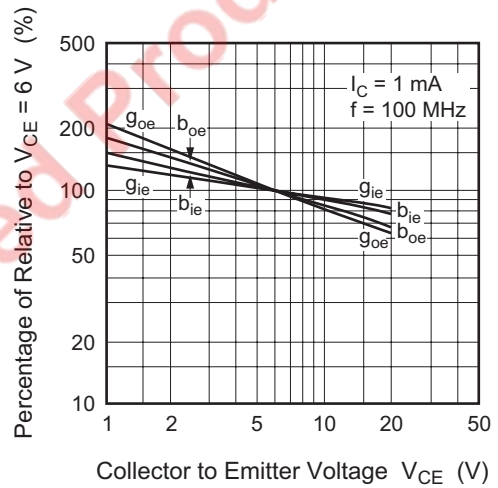
Transfer Admittance vs. Collector to Emitter Voltage



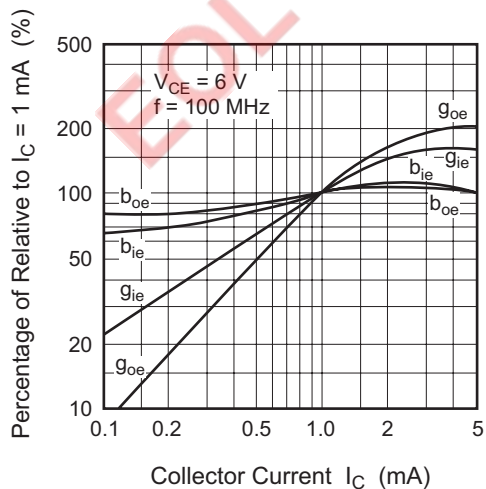
Transfer Admittance vs. Collector Current



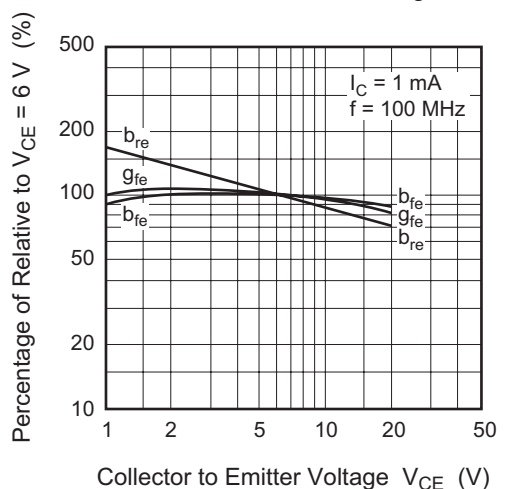
Input/Output Admittance vs. Collector to Emitter Voltage

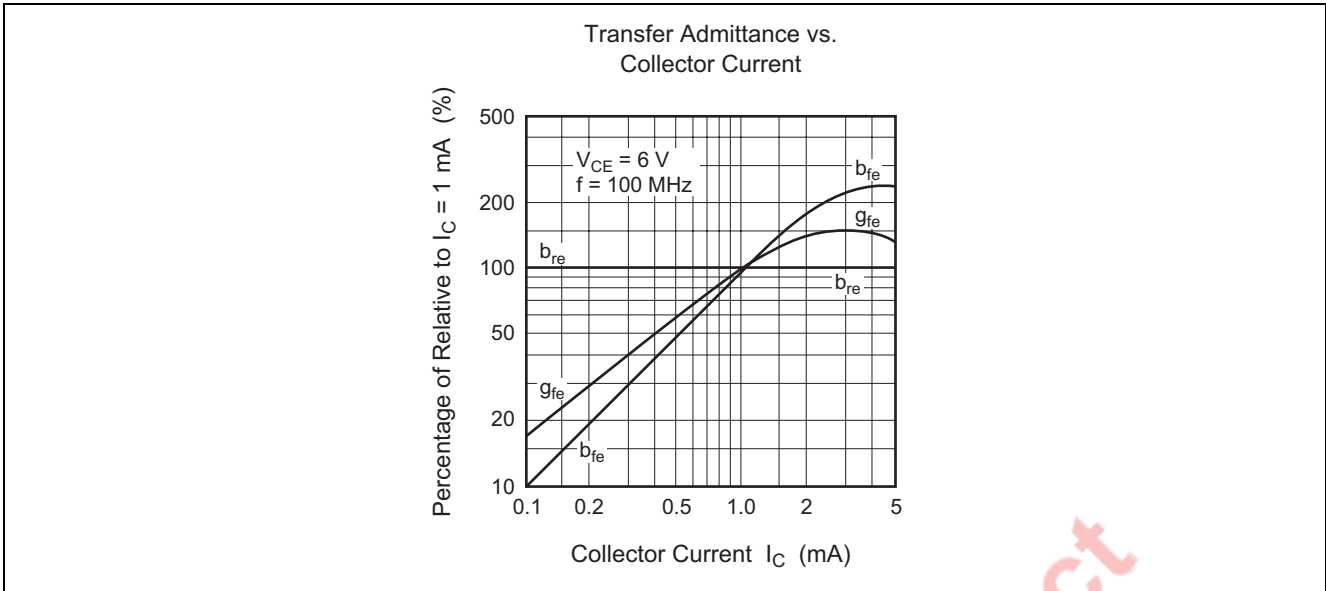


Input/Output Admittance vs. Collector Current



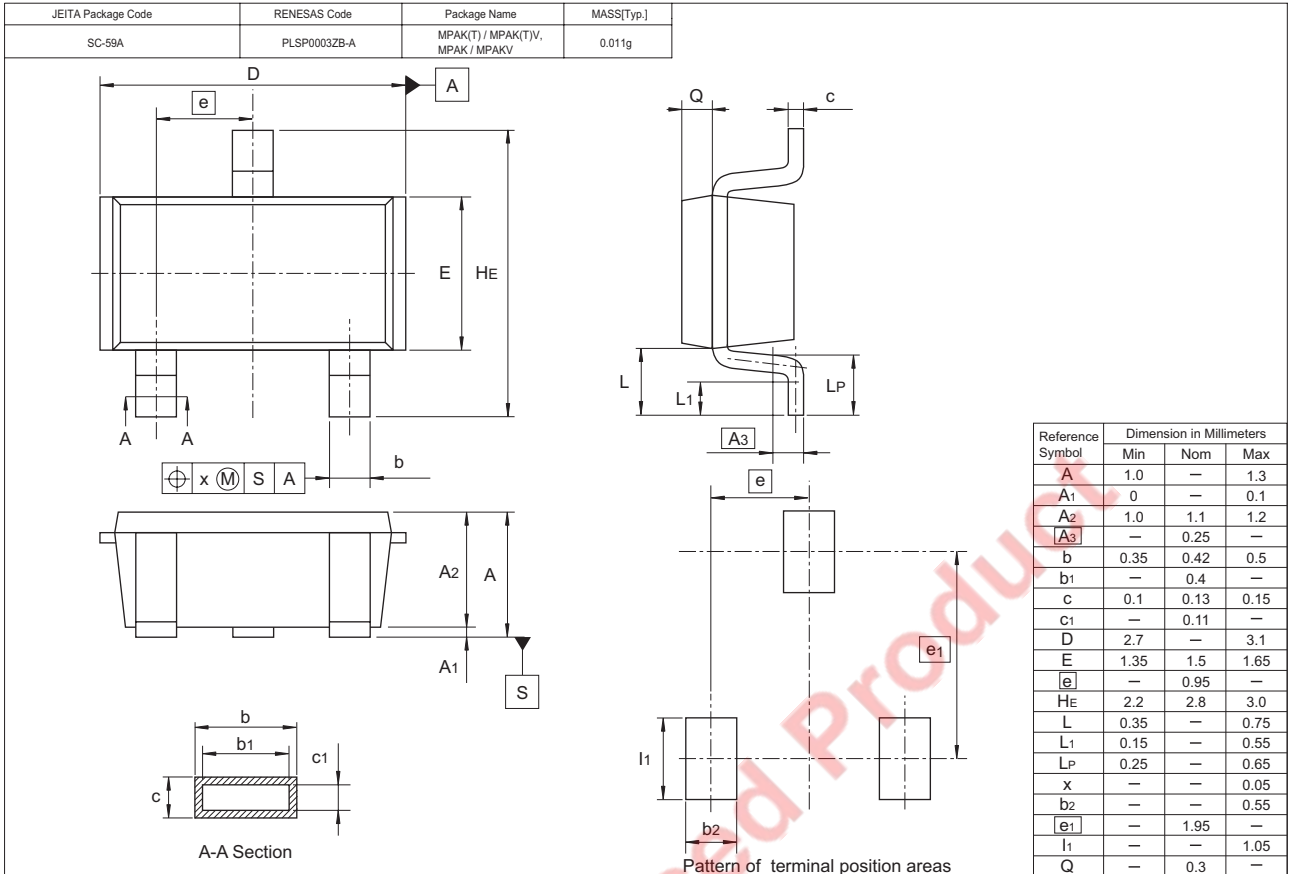
Transfer Admittance vs. Collector to Emitter Voltage





EOL announced Product

### Package Dimensions



### Ordering Information

Part Name	Quantity	Shipping Container
2SC2619FBTR-E	3000	φ 178 mm Reel, 8 mm Emboss Taping
2SC2619FCTR-E		

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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